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FAX NO.

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DOCKET NO. END920010002US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ray *et al.*

Examiner: Nguyen, Ha T

Serial No.: 09/779,812

Art Unit: 2812

Filed: 2/08/01

For: LEAD-FREE SOLDER STRUCTURE AND METHOD FOR HIGH FATIGUE LIFE

*please enter
6-23-03 J.W.
Commissioner for Patents
Washington, DC 20231*

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JUN 06 2003

TECHNOLOGY CENTER 2800

AMENDMENT

Sir:

In response to the Final Office Action mailed April 16, 2003, please amend the above-identified application as follows:

09/779,812